



General Description

The WSP4606A is the highest performance trench N-ch and P-ch MOSFETs with extreme high cell density, which provide excellent RDSON and gate charge for most of the synchronous buck converter applications.

The WSP4606A meet the RoHS and Green Product requirement, 100% EAS guaranteed with full function reliability approved.

Features

- Advanced high cell density Trench technology
- Super Low Gate Charge
- Excellent CdV/dt effect decline
- 100% EAS Guaranteed
- Green Device Available

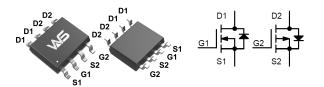
Product Summery

BVDSS	RDSON	ID
30V	22mΩ	6.8A
-30V	45mΩ	-5.6A

Applications

- Power management in half bridge and inverters
- DC-DC Converter
- Load Switch

SOP-8 Pin Configuration



Absolute Maximum Ratings

Symbol	Parameter	Rati		
Symbol			P-Channel	Units
V _{DS}	Drain-Source Voltage	30	-30	V
V_{GS}	Gate-Source Voltage	±20	±20	V
I _D @T _C =25℃	Continuous Drain Current, V _{GS} @ 10V ¹	6.8	-5.6	Α
I _D @T _C =100℃	Continuous Drain Current, V _{GS} @ 10V ¹	5.8	-3.9	Α
I _{DM}	Pulsed Drain Current ²	19	-11	Α
EAS	Single Pulse Avalanche Energy ³	71	58	mJ
I _{AS}	Avalanche Current	20	-18	Α
P _D @T _C =25℃	Total Power Dissipation ⁴	2.5	2.08	W
T _{STG}	Storage Temperature Range	-55 to 150	-55 to 150	$^{\circ}$ C
TJ	Operating Junction Temperature Range	-55 to 150	-55 to 150	$^{\circ}$ C

Thermal Data

Symbol	Parameter		Max.	Unit
R _{0JA}	Thermal Resistance Junction-Ambient ¹		85	°C/W
R _{0JC}	Thermal Resistance Junction-Case ¹		50	°C/W





Electrical Characteristics (T_J=25 °C, unless otherwise noted)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V , I _D =250uA	30			V
$\triangle BV_{DSS}/\triangle T_{J}$	BVDSS Temperature Coefficient	Reference to 25°C , I _D =1mA		0.034		V/°C
В	Static Drain-Source On-Resistance ²	V _{GS} =10V , I _D =6.3A		22	35	m()
R _{DS(ON)}	Static Dialit-Source Off-Resistance	V _{GS} =4.5V , I _D =4.5A		30	45	mΩ
V _{GS(th)}	Gate Threshold Voltage	-V _{GS} =V _{DS} . In =250uA	1.0	1.5	2.5	٧
$\triangle V_{GS(th)}$	V _{GS(th)} Temperature Coefficient	V _{GS} -V _{DS} , I _D -250UA		-5.8		mV/℃
	Drain Source Lookage Current	V _{DS} =30V , V _{GS} =0V , T _J =25℃			1	
I _{DSS}	Drain-Source Leakage Current	V _{DS} =30V , V _{GS} =0V , T _J =55℃			5	uA
I _{GSS}	Gate-Source Leakage Current	$V_{GS}=\pm 20V$, V_{DS} =0V			±100	nA
gfs	Forward Transconductance	V _{DS} =15V , I _D =5A		20		S
R _g	Gate Resistance	V _{DS} =24V , V _{GS} =0V , f=1MHz		1.8		Ω
Qg	Total Gate Charge (4.5V)			3.5		
Q _{gs}	Gate-Source Charge	V_{DS} =20V , V_{GS} =4.5V , I_{D} =6A		1.3		nC
Q_gd	Gate-Drain Charge			1.7		
T _{d(on)}	Turn-On Delay Time			4.5		
Tr	Rise Time	V_{DD} =12V , V_{GS} =10V , R_{G} =3.3 Ω		2.7		
T _{d(off)}	Turn-Off Delay Time	I _D =5A		14.9		ns
T _f	Fall Time			2.9		
C _{iss}	Input Capacitance	V _{DS} =25V , V _{GS} =0V , f=1MHz		373		
C _{oss}	Output Capacitance			67		pF
C _{rss}	Reverse Transfer Capacitance			41		

Diode Characteristics

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
Is	Continuous Source Current ^{1,6}	V_G = V_D = $0V$, Force Current			2.5	Α
I _{SM}	Pulsed Source Current ^{2,6}				64	Α
V_{SD}	Diode Forward Voltage ²	V _{GS} =0V , I _S =5A , T _J =25℃			1.2	V

Note:

- 1. The data tested by surface mounted on a 1 inch² FR-4 board with 2OZ copper,t<10sec.
- 2.The data tested by pulsed , pulse width \leq 300us , duty cycle \leq 2%
- 3. The EAS data shows Max. rating . The test condition is V_{DD} =25V, V_{GS} =10V,L=0.1mH, I_{AS} =10A
- 5.The Min. value is 100% EAS tested guarantee.
- 6. The data is theoretically the same as I_D and I_{DM} , in real applications, should be limited by total power dissipation.



N-Ch and P-Channel MOSFET

Electrical Characteristics (T_J=25 °C, unless otherwise noted)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V , I _D =-250uA	-30			V
$\triangle BV_{DSS}/\triangle T_{J}$	BV _{DSS} Temperature Coefficient	Reference to 25 $^{\circ}\!$		-0.085		V/℃
В	Static Drain-Source On-Resistance ²	V _{GS} =-10V , I _D =-5.5A		45	50	mΩ
R _{DS(ON)}	Static Dialii-Source Off-Resistance	V _{GS} =-4.5V , I _D =-4.0A		60	68	
$V_{GS(th)}$	Gate Threshold Voltage	Ves=Ves . In =-250uA	-1.0	-1.5	-2.5	V
$\triangle V_{GS(th)}$	V _{GS(th)} Temperature Coefficient	W _{GS} =V _{DS} , I _D =-250uA		0.375		mV/℃
	Drain Source Leakage Current	V_{DS} =-24V , V_{GS} =0V , T_J =25 $^{\circ}$ C			1	
I _{DSS}	Drain-Source Leakage Current	V _{DS} =-24V , V _{GS} =0V , T _J =55°C			5	uA
I _{GSS}	Gate-Source Leakage Current	V_{GS} = $\pm 20 V$, V_{DS} = $0 V$			±100	nA
gfs	Forward Transconductance	V _{DS} =-10V , I _D =-6A		19		S
Qg	Total Gate Charge (-4.5V)			13.6		
Q_gs	Gate-Source Charge	V_{DS} =-20V , V_{GS} =-4.5V , I_{D} =-6A		2.5		nC
Q_{gd}	Gate-Drain Charge			3.2		
T _{d(on)}	Turn-On Delay Time			8		
Tr	Rise Time	V_{DD} =-12V , V_{GS} =-10V , R_{G} =3.3 Ω ,		6		20
T _{d(off)}	Turn-Off Delay Time	I _D =-5A		17		ns
T _f	Fall Time			5		
C _{iss}	Input Capacitance			760		
Coss	Output Capacitance	V _{DS} =-25V , V _{GS} =0V , f=1MHz		140		pF
C _{rss}	Reverse Transfer Capacitance			95		

Diode Characteristics

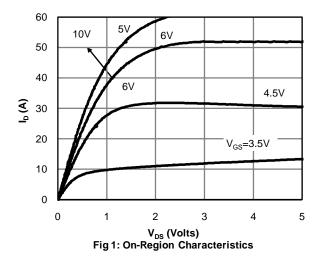
Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
Is	Continuous Source Current ^{1,6}	-V _G =V _D =0V , Force Current			-3.5	Α
I _{SM}	Pulsed Source Current ^{2,6}				-40	Α
V_{SD}	Diode Forward Voltage ²	V _{GS} =0V , I _S =-3.5A , T _J =25℃			-1.2	V

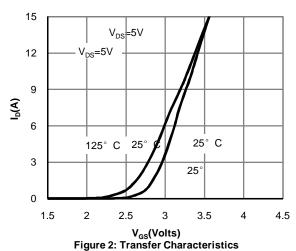
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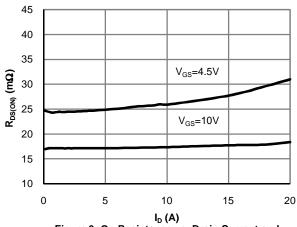
- 1.The data tested by surface mounted on a 1 inch² FR-4 board with 2OZ copper,t<10sec.
- 2.The data tested by pulsed , pulse width \leq 300us , duty cycle \leq 2%
- 3. The EAS data shows Max. rating . The test condition is V_{DD} =-25V, V_{GS} =-10V,L=0.1mH, I_{AS} =-10A
- 4.The power dissipation is limited by 150 ℃ junction temperature
- 5. The Min. value is 100% EAS tested guarantee.
- 6. The data is theoretically the same as I_D and I_{DM} , in real applications, should be limited by total power dissipation.

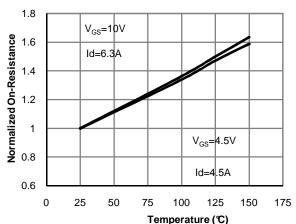


N-Channel Typical Characteristics

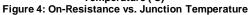


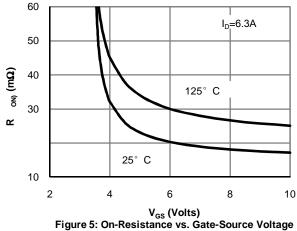


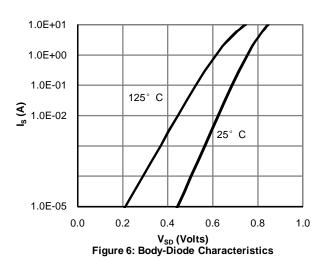




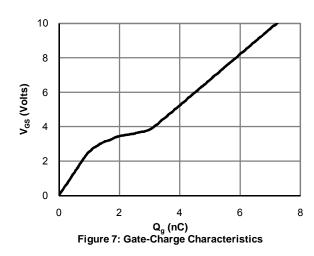
 $\mbox{I}_{\mbox{\tiny D}}\left(\mbox{A}\right)$ Figure 3: On-Resistance vs. Drain Current and **Gate Voltage**

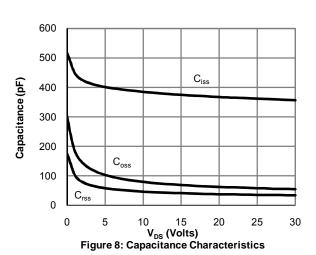


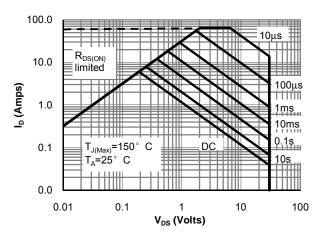












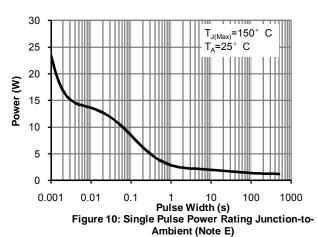


Figure 9: Maximum Forward Biased Safe Operating Area (Note E)

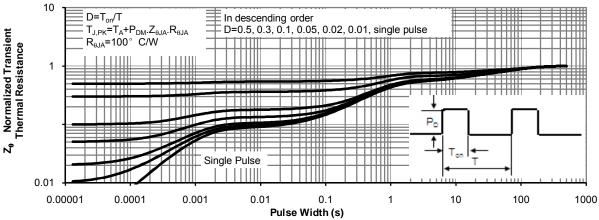
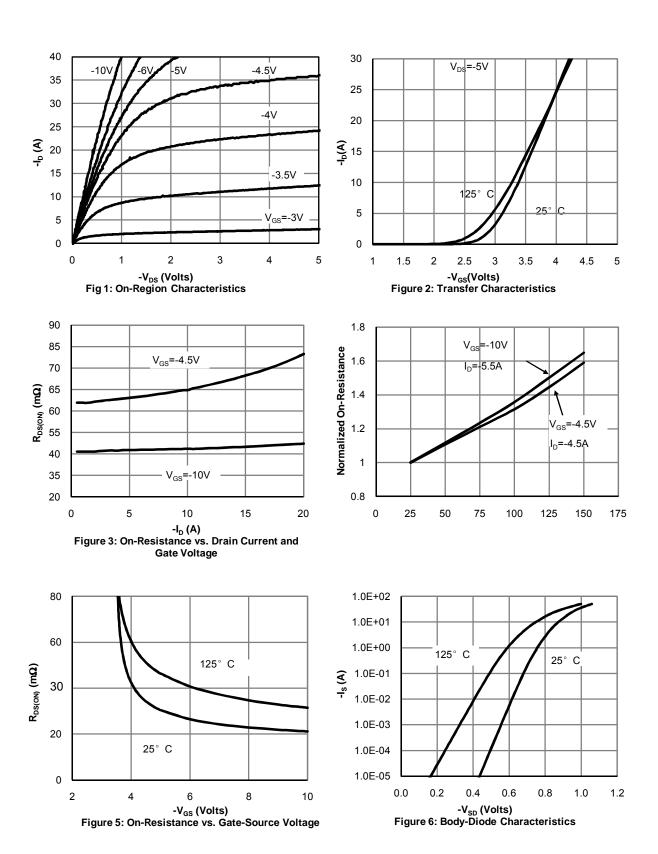


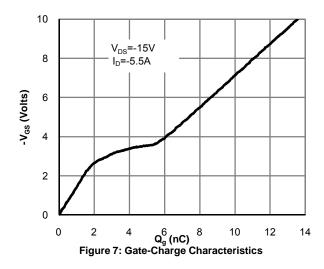
Figure 11: Normalized Maximum Transient Thermal Impedance

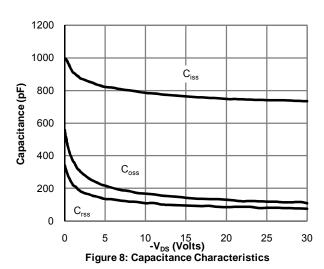


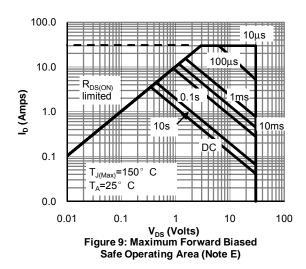
P-Channel Typical Characteristics

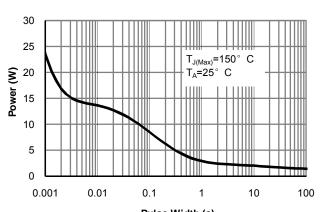












Pulse Width (s)
Figure 10: Single Pulse Power Rating Junction-toAmbient (Note E)

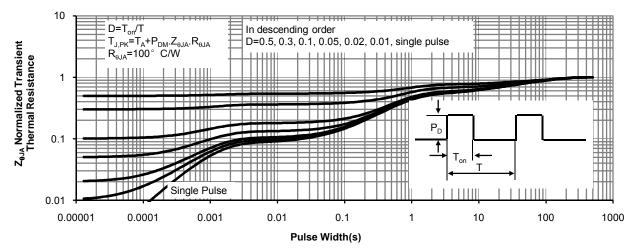


Figure 11: Normalized Maximum Transient Thermal Impedance



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